6-Pin DIP Schmitt Trigger Output Optocoupler

The H11N1M has a high-speed integrated circuit detector optically coupled to an aluminium gallium arsenide (AlGaAs) infrared emitting diode. The output incorporates a Schmitt trigger, which provides hysteresis for noise immunity and pulse shaping. The detector circuit is optimized for simplicity of operation and utilizes an open-collector output for maximum application flexibility.

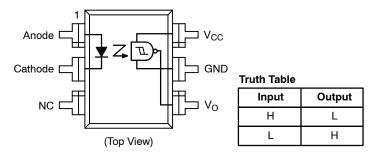
Features

- High Data Rate, 5 MHz Typical (NRZ)
- Free from Latch-up and Oscillation Throughout Voltage and Temperature Ranges
- Microprocessor Compatible Drive
- Logic Compatible Output Sinks 16 mA at 0.5 V Maximum
- Guaranteed On/Off Threshold Hysteresis
- Wide Supply Voltage Capability, Compatible with All Popular Logic Systems
- Safety and Regulatory Approvals:
 - UL1577, 4,170 VAC_{RMS} for 1 Minute
 - DIN-EN/IEC60747-5-5, 850 V Peak Working Insulation Voltage

Applications

- Logic-to-Logic Isolator
- Programmable Current Level Sensor
- Line Receiver Eliminate Noise and Transient Problems
- AC to TTL Conversion Square Wave Shaping
- Interfaces Computers with Peripherals
- Isolated Power MOS Driver for Power Supplies

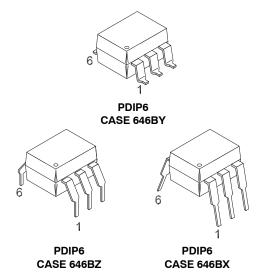
SCHEMATIC

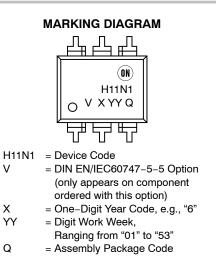




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ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

Table 1. SAFETY AND INSULATION RATINGS As per DIN EN/IEC 60747–5–5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

	Parameter		Characte	ristics
nstallation Classifications per DIN VDE 0110/1.89 Table 1,				/
For Rated Mains	Voltage	< 300 V _{RMS}	I–IV	/
Climatic Classifica	ation		55/100	0/21
Pollution Degree	(DIN VDE 0110/1.89)		2	
Comparative Trac	king Index		175	5
Symbol	Paramete	er	Value	Unit
V _{PR}	Input-to-Output Test Voltage, Method A, $V_{IORM} x 1.6 = V_{PR}$, Type and Sample Test with t _m = 10 s, Partial Discharge < 5 pC		1360	V _{peak}
	Input–to–Output Test Voltage, Method B, V _{IORM} x 1.875 = V _{PR} , 100% Production Test with $t_m = 1 \text{ s}$, Partial Discharge < 5 pC		1594	V _{peak}
VIORM	Maximum Working Insulation Voltage	Maximum Working Insulation Voltage		V _{peak}
VIOTM	Highest Allowable Over-Voltage		6,000	V _{peak}
	External Creepage		≥ 7	mm
	External Clearance		≥ 7	mm
	External Clearance (for Option TV, 0.4" Lea	d Spacing)	≥ 10	mm
DTI	Distance Through Insulation (Insulation Thio	kness)	≥ 0.5	mm
Τ _S	Case Temperature (Note 1)		175	°C
I _{S,INPUT}	Input Current (Note 1)	(Note 1)		mA
P _{S,OUTPUT}	Output Power (Note 1)		800	mW
R _{IO}	Insulation Resistance at T _S , V _{IO} = 500 V (No	ote 1)	> 10 ⁹	Ω

1. Safety limit values - maximum values allowed in the event of a failure.

Table 2. ABSOLUTE MAXIMUM RATINGS T_{A} = $25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Value	Units
OTAL DEVICE			
T _{STG}	Storage Temperature	-40 to +125	°C
T _{OPR}	Operating Temperature	-40 to +85	°C
TJ	Junction Temperature	-40 to +125	°C
T _{SOL}	Lead Solder Temperature	260 for 10 seconds	°C
PD	Total Device Power Dissipation at 25°C	210	mW
	Derate above 25°C	2.94	mW/°C
MITTER	·	•	
١ _F	Continuous Forward Current	30	mA
V _R	Reverse Voltage	6	V
l _F (pk)	Forward Current – Peak (1 µs pulse, 300 pps)	100	mA
PD	LED Power Dissipation	60	mW
ETECTOR			
PD	Detector Power Dissipation	150	mW
Vo	V ₄₅ Allowed Range	0 to 16	V
V _{CC}	V ₆₅ Allowed Range	3 to 16	V
Ι _Ο	I ₄ Output Current	50	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
EMITTER						
V _F	Input Forward Voltage	I _F = 10 mA		1.4	2.0	V
		I _F = 0.3 mA	0.75	1.25		
I _R	Reverse Current	V _R = 5 V			10	μA
CJ	Capacitance	V = 0 V, f = 1.0 MHz			100	pF
DETECTOR						
V _{CC}	Operating Voltage Range		4		15	V
I _{CC(off)}	Supply Current	I _F = 0 mA, V _{CC} = 5 V		6	10	mA

 $I_F = 0 \text{ mA}, V_{CC} = V_0 = 15 \text{ V}$

100

μA

Table 4. TRANSFER CHARACTERISTICS T_A = 25°C unless otherwise specified

Output Current, High

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
I _{CC(on)}	Supply Current	I _F = 10 mA, V _{CC} = 5 V		6.5	10.0	mA
V _{OL}	Output Voltage, Low	$ \begin{array}{l} R_{L} = 270 \; \Omega, \; V_{CC} = 5 \; V, \\ I_{F} = I_{F(on)} \; Maximum \end{array} $			0.5	V
I _{F(on)}	Turn-On Threshold Current	$\rm R_L$ = 270 $\Omega, V_{\rm CC}$ = 5 V (Note 2)	0.8		3.2	mA
I _{F(off)}	Turn–Off Threshold Current	R_L = 270 Ω , V_{CC} = 5 V	0.3			mA
I _{F(off)} / I _{F(on)}	Hysteresis Ratio	R_L = 270 Ω, V_{CC} = 5 V	0.65		0.95	

Table 5. SWITCHING SPEED

I_{OH}

Symbol	AC Characteristics	Test Conditions	Min	Тур	Max	Units
t _{on}	Turn-On Time	C = 120 pF, t_P = 1 μ s, R _E = (Note 3), Figure 7		100	330	ns
t _r	Rise Time	$\label{eq:constraint} \begin{array}{l} C = 120 \text{ pF}, \text{t}_{P} = 1 \mu\text{s}, \\ \text{R}_{E} = (\text{Note 3}), \text{ Figure 7} \end{array}$		7.5		ns
t _{off}	Turn–Off Time	C = 120 pF, t_P = 1 μ s, R _E = (Note 3), Figure 7		150	330	ns
t _f	Fall Time	$\label{eq:constraint} \begin{array}{l} C = 120 \text{ pF}, \text{t}_{P} = 1 \mu\text{s}, \\ \text{R}_{E} = (\text{Note 3}), \text{ Figure 7} \end{array}$		12		ns
	Data Rate			5		MHz

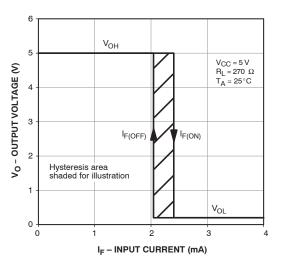
Table 6. ISOLATION CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
V _{ISO}	Input-Output Isolation Voltage	t = 1 Minute	4170			VAC _{RMS}
C _{ISO}	Isolation Capacitance	V _{I-O} = 0 V, f = 1 MHz		0.4	0.6	pF
R _{ISO}	Isolation Resistance	$V_{I-O}=\pm 500 \text{ VDC}, T_A=25^\circ \text{C}$	10 ¹¹			Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Maximum I_{F(on)} is the maximum current required to trigger the output. For example, a 3.2 mA maximum trigger current would require the LED to be driven at a current greater than 3.2 mA to guarantee the device will turn on. A 10% guard band is recommended to account for degradation of the LED over its lifetime. The maximum allowable LED drive current is 30 mA.

3. H11N1: $R_E = 910 \Omega$



TYPICAL CHARACTERISTICS



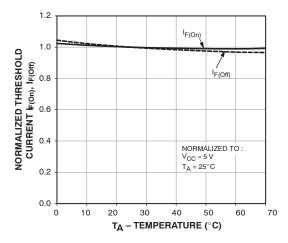


Figure 3. Threshold Current vs. Temperature

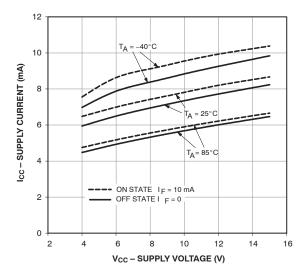


Figure 5. Supply Current vs. Supply Voltage

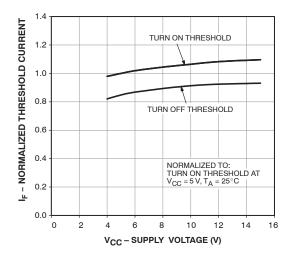


Figure 2. Threshold Current vs. Supply Voltage

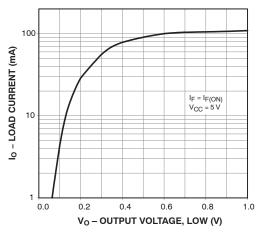
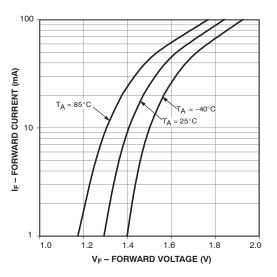


Figure 4. Load Current vs. Output Voltage





TEST CIRCUIT

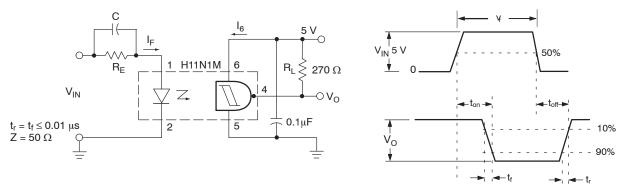
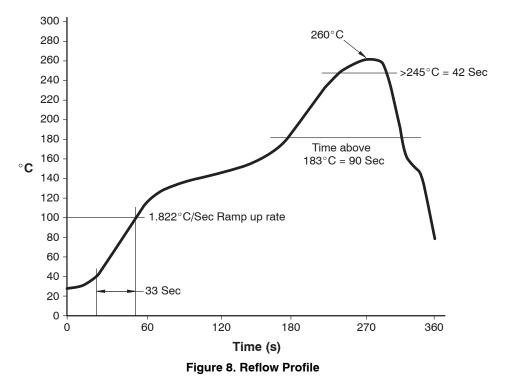


Figure 7. Switching Test Circuit and Waveforms



REFLOW PROFILE

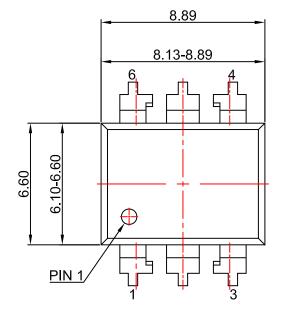
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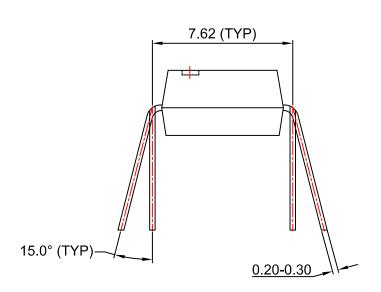
Part Number	Package	Packing Method
H11N1M	DIP 6-Pin	Tube (50 Units)
H11N1SM	SMT 6-Pin (Lead Bend)	Tube (50 Units)
H11N1SR2M	SMT 6-Pin (Lead Bend)	Tape and Reel (1000 Units)
H11N1VM	DIP 6-Pin, DIN EN/IEC60747-5-5 Option	Tube (50 Units)
H11N1SVM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	Tube (50 Units)
H11N1SR2VM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	Tape and Reel (1000 Units)
H11N1TVM	DIP 6-Pin, 0.4" Lead Spacing, DIN EN/IEC60747-5-5 Option	Tube (50 Units)

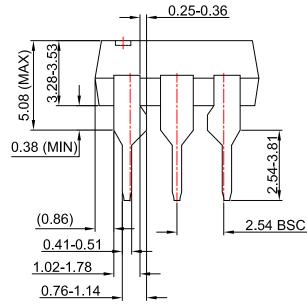


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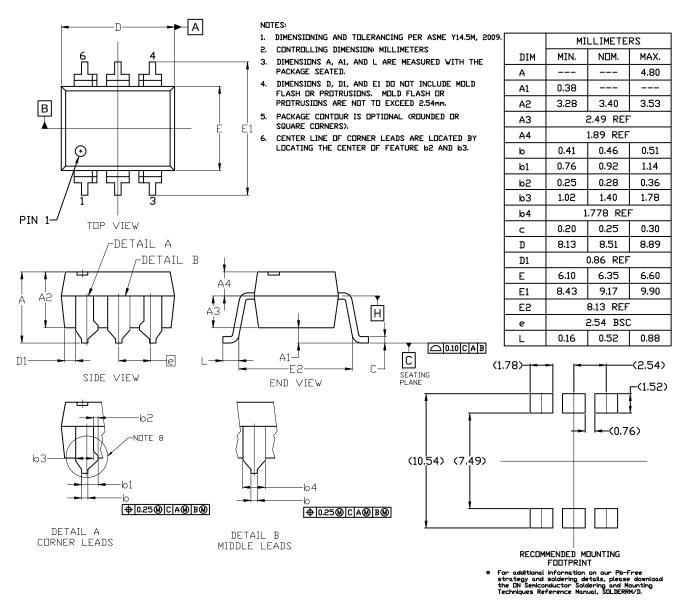
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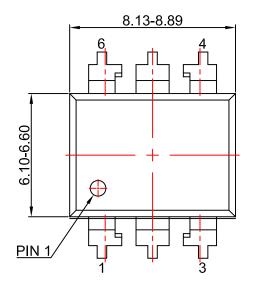


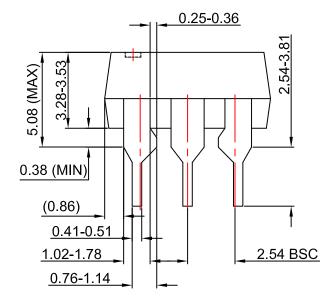
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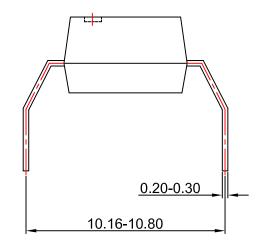


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